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ORIGINALLY FILED

Docket No.: 42390P13269

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re the Application of:

RAJEN DIAS, ET AL.

Application No.: 10/000,252

Filed: November 30, 2001

For: **BACKSIDE METALLIZATION ON
MICROELECTRONIC DICE HAVING
BEVELED SIDES FOR EFFECTIVE THERMAL
CONTACT WITH HEAT DISSIPATION
DEVICES**

Art Group: 2812

Examiner: Not Assigned

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.97

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In accordance with the duty of disclosure under 37 CFR § 1.56 and in accordance with 37 C.F.R. § 1.97, enclosed is a copy of Information Disclosure Citation Form PTO/SB/08. Copies of the references cited on PTO/SB/08 are enclosed herewith. It is respectfully requested that the cited references be considered and that the enclosed copy of PTO/SB/08 be initialed by the Examiner to indicate such consideration and a copy thereof returned to applicant(s).

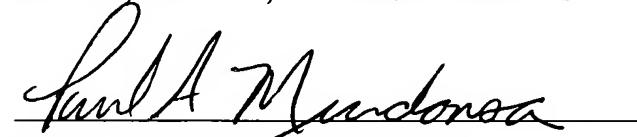
Pursuant to 37 C.F.R. § 1.97, the submission of this Information Disclosure Statement is not to be construed as a representation that a search has been made and is not to be construed as an admission that the information cited in this statement is material to patentability.

Please charge any additional fee due to Deposit Account 02-2666. A duplicate copy of the Fee Transmittal is enclosed for this purpose.

Respectfully submitted,

BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP

Date: March 08, 2002


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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 to the Patent and Trademark Office on: March 8, 2002.

Deborah L. Higham

03/08/02

Date

